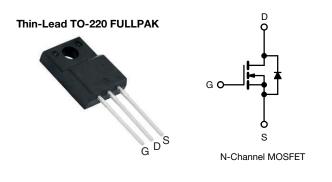
SiHA12N60E



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E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.38			
Q _g max. (nC)	58			
Q _{gs} (nC)	6			
Q _{gd} (nC)	13			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Adaptors
 - Televisions
 - Game console
- Computing
 - Adaptors
 - ATX power supply

ORDERING INFORMATION			
Package	Thin-Lead TO-220 FULLPAK		
Lead (Pb)-free	SiHA12N60E-E3		
Lead (Pb)-free and halogen-free	SiHA12N60E-GE3		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	v	
Gate-source voltage			V _{GS}	± 30		
Continuous drain surrant $(T_{1} - 150 ^{\circ}\text{C})^{\frac{1}{2}}$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1-	12	А	
Continuous drain current (T _J = 150 °C) ^e	V _{GS} at 10 V	T _C = 100 °C	ID	7.8		
Pulsed drain current ^a			I _{DM}	27	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	117	mJ	
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		-1\ / / -1+	70	1//	
Reverse diode dV/dt ^d			dV/dt	5	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 Ω , I_{AS} = 4.5 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$
- e. Limited by maximum junction temperature



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PARAMETER	SYMBOL	TYP.	N	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65 - 3.8						
Maximum junction-to-case (drain)	R _{thJC}			3.8	°C/W			
			I					
SPECIFICATIONS ($T_J = 25 \degree C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL	1	T CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static							1	
Drain-source breakdown voltage	V _{DS}	V _{CS} :	= 0 V, I _D = 250 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		$e \text{ to } 25 \text{ °C, } I_D = 1 \text{ mA}$	-	0.71	-	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250 μA	2	-	4	V	
	- 63(iii)		$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA	
			$= 600 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$		_	1	- μA	
Zero gate voltage drain current	I _{DSS}		$V_{\rm r}, V_{\rm GS} = 0 V, T_{\rm J} = 125$		-	10		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	$I_{\rm D} = 6 \rm A$	-	0.32	0.38	Ω	
Forward transconductance	g _{fs}	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		-	3.8	-	S	
Dynamic		1 20		<u>I</u>	Į	Į		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	937	-	pF	
Output capacitance	C _{oss}			-	53	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	41	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	136	-		
Total gate charge	Qg			-	29	58	nC	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, V_{DS} = 480 \text{ V}$		6	-		
Gate-drain charge	Q _{gd}				13	-		
Turn-on delay time	t _{d(on)}				14	28		
Rise time	t _r	V	= 480 V, I _D = 6 A,	-	19	38	1	
Turn-off delay time	t _{d(off)}	$V_{DD} = 460$ V, $I_D = 6$ A, $V_{GS} = 10$ V, $R_g = 9.1 \Omega$		-	35	70	- ns	
Fall time	t _f			-	19	38		
Gate input resistance	Rg	f = 1 MHz, open drain		-	1.1	-	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed diode forward current	I _{SM}			s -	-	48	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 6 \text{ A,}$ $dI/dt = 100 \text{ A/}\mu\text{s, } V_{R} = 25 \text{ V}$		-	350	-	ns	
Reverse recovery charge	Q _{rr}			-	4	-	μ	
Reverse recovery current	I _{RRM}			_	19	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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SiHA12N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

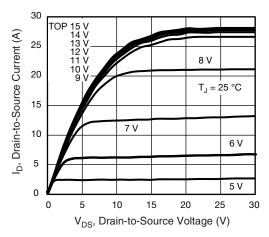


Fig. 1 - Typical Output Characteristics

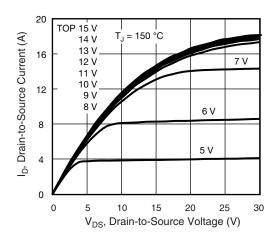
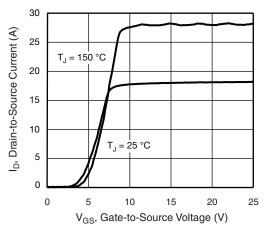


Fig. 2 - Typical Output Characteristics





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3 6 On Resistance (Normalized) 2.5 R_{DS(on)}, Drain-to-Source 2 1.5 1 10 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

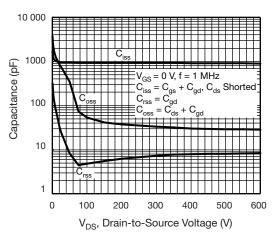


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

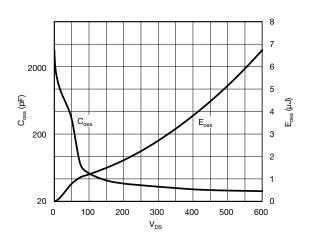


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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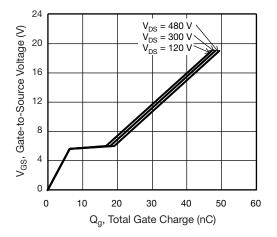


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

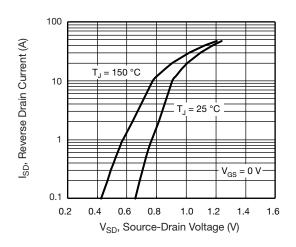


Fig. 8 - Typical Source-Drain Diode Forward Voltage

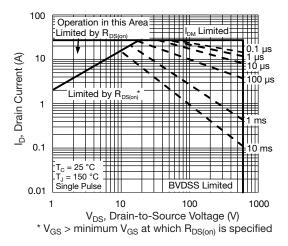


Fig. 9 - Maximum Safe Operating Area

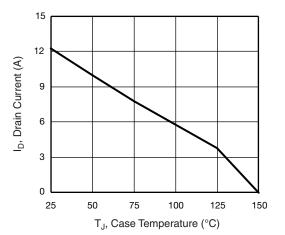


Fig. 10 - Maximum Drain Current vs. Case Temperature

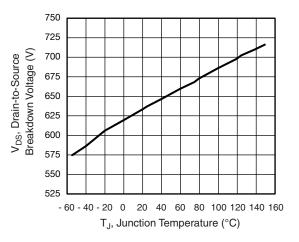


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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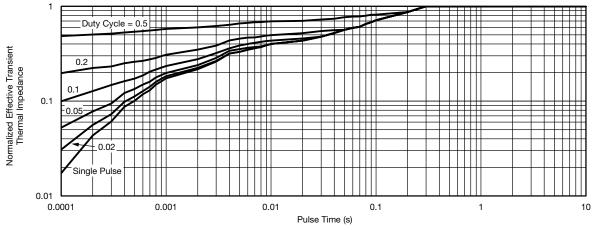


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

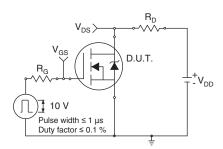


Fig. 13 - Switching Time Test Circuit

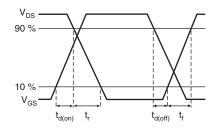


Fig. 14 - Switching Time Waveforms

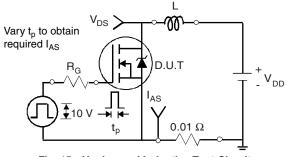


Fig. 15 - Unclamped Inductive Test Circuit

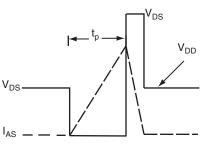


Fig. 16 - Unclamped Inductive Waveforms

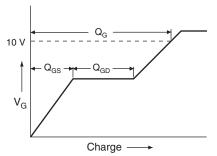


Fig. 17 - Basic Gate Charge Waveform

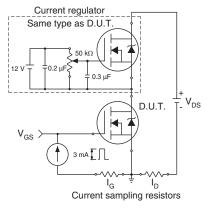


Fig. 18 - Gate Charge Test Circuit

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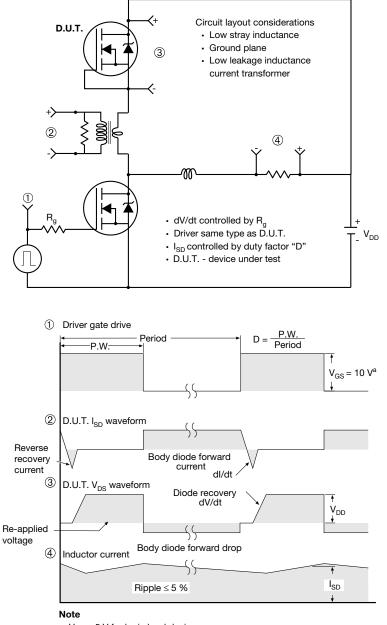
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

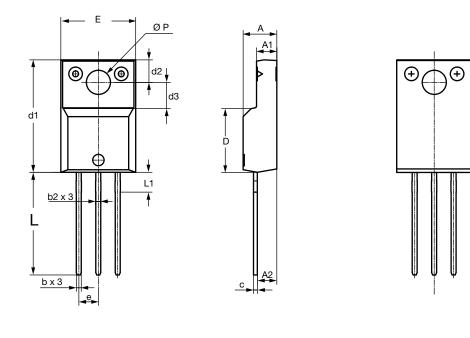
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•		

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